

Preliminary datasheet

EasyDUAL module with CoolSiC™ Trench MOSFET and PressFIT / NTC

Features

- Electrical features
 - $V_{DS} = 1200\text{ V}$
 - $I_{DN} = 50\text{ A}$ / $I_{DRM} = 100\text{ A}$
 - Low inductive design
 - Low switching losses
- Mechanical features
 - PressFIT contact technology
 - Integrated NTC temperature sensor
 - Rugged mounting due to integrated mounting clamps



Typical appearance

Potential applications

- High-frequency switching application
- DC/DC converter
- UPS systems
- DC charger for EV

Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description

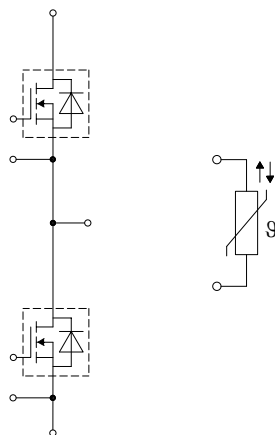


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1 Package

Table 1 Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	V_{ISOL}	RMS, $f = 50 \text{ Hz}$, $t = 1 \text{ min}$	3.0	kV
Internal isolation		basic insulation (class 1, IEC 61140)	Al_2O_3	
Comparative tracking index	CTI		> 200	
Relative thermal index (electrical)	RTI	housing	140	°C

Table 2 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Stray inductance module	L_{sCE}			9		nH
Module lead resistance, terminals - chip	$R_{CC'+EE'}$	$T_H = 25 \text{ °C}$, per switch		2.1		mΩ
Storage temperature	T_{stg}		-40		125	°C
Mounting force per clamp	F		20		50	N
Weight	G			24		g

Note: The current under continuous operation is limited to 25 A rms per connector pin.

2 MOSFET

Table 3 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Drain-source voltage	V_{DSS}		$T_{vj} = 25 \text{ °C}$	1200	V
Continuous DC drain current	I_{DDC}	$T_{vj} = 175 \text{ °C}$, $V_{GS} = 18 \text{ V}$	$T_H = 80 \text{ °C}$	50	A
Repetitive peak drain current	I_{DRM}	verified by design, t_p limited by T_{vjmax}		100	A
Gate-source voltage, max. transient voltage	V_{GS}	$D < 0.01$		-10/23	V
Gate-source voltage, max. static voltage	V_{GS}			-7/20	V

Table 4 Recommended values

Parameter	Symbol	Note or test condition	Values	Unit
On-state gate voltage	$V_{GS(on)}$		15...18	V
Off-state gate voltage	$V_{GS(off)}$		-5...0	V

Table 5 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Drain-source on-resistance	$R_{DS(on)}$	$I_D = 50 \text{ A}$	$V_{GS} = 18 \text{ V}, T_{vj} = 25 \text{ }^\circ\text{C}$		16.2		mΩ
			$V_{GS} = 18 \text{ V}, T_{vj} = 125 \text{ }^\circ\text{C}$		26.1		
			$V_{GS} = 18 \text{ V}, T_{vj} = 175 \text{ }^\circ\text{C}$		34.7		
			$V_{GS} = 15 \text{ V}, T_{vj} = 25 \text{ }^\circ\text{C}$		19.4		
Gate threshold voltage	$V_{GS(th)}$	$I_D = 20 \text{ mA}, V_{DS} = V_{GS}, T_{vj} = 25 \text{ }^\circ\text{C}, (\text{tested after } 1\text{ms pulse at } V_{GS} = +20 \text{ V})$		3.45	4.3	5.15	V
Total gate charge	Q_G	$V_{DD} = 800 \text{ V}, V_{GS} = -3/18 \text{ V}$			0.149		μC
Internal gate resistor	R_{Gint}	$T_{vj} = 25 \text{ }^\circ\text{C}$			4.1		Ω
Input capacitance	C_{ISS}	$f = 100 \text{ kHz}, V_{DS} = 800 \text{ V}, V_{GS} = 0 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$		4.4		nF
Output capacitance	C_{OSS}	$f = 100 \text{ kHz}, V_{DS} = 800 \text{ V}, V_{GS} = 0 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$		0.21		nF
Reverse transfer capacitance	C_{rss}	$f = 100 \text{ kHz}, V_{DS} = 800 \text{ V}, V_{GS} = 0 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$		0.014		nF
C_{OSS} stored energy	E_{OSS}	$V_{DS} = 800 \text{ V}, V_{GS} = -3/18 \text{ V}, T_{vj} = 25 \text{ }^\circ\text{C}$			86		μJ
Drain-source leakage current	I_{DSS}	$V_{DS} = 1200 \text{ V}, V_{GS} = -3 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$		0.03	210	μA
Gate-source leakage current	I_{GSS}	$V_{DS} = 0 \text{ V}, T_{vj} = 25 \text{ }^\circ\text{C}$	$V_{GS} = 20 \text{ V}$			400	nA
Turn-on delay time (inductive load)	$t_{d on}$	$I_D = 50 \text{ A}, R_{Gon} = 6.8 \text{ } \Omega, V_{DD} = 600 \text{ V}, V_{GS} = -3/18 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$		36		ns
			$T_{vj} = 125 \text{ }^\circ\text{C}$		36		
			$T_{vj} = 175 \text{ }^\circ\text{C}$		36		
Rise time (inductive load)	t_r	$I_D = 50 \text{ A}, R_{Gon} = 6.8 \text{ } \Omega, V_{DD} = 600 \text{ V}, V_{GS} = -3/18 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$		43		ns
			$T_{vj} = 125 \text{ }^\circ\text{C}$		43		
			$T_{vj} = 175 \text{ }^\circ\text{C}$		43		
Turn-off delay time (inductive load)	$t_{d off}$	$I_D = 50 \text{ A}, R_{Goff} = 1 \text{ } \Omega, V_{DD} = 600 \text{ V}, V_{GS} = -3/18 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$		54		ns
			$T_{vj} = 125 \text{ }^\circ\text{C}$		58		
			$T_{vj} = 175 \text{ }^\circ\text{C}$		60		
Fall time (inductive load)	t_f	$I_D = 50 \text{ A}, R_{Goff} = 1 \text{ } \Omega, V_{DD} = 600 \text{ V}, V_{GS} = -3/18 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$		14		ns
			$T_{vj} = 125 \text{ }^\circ\text{C}$		14		
			$T_{vj} = 175 \text{ }^\circ\text{C}$		14		

(table continues...)

Table 5 (continued) **Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Turn-on energy loss per pulse	E_{on}	$I_D = 50\text{ A}$, $V_{DD} = 600\text{ V}$, $L_\sigma = 35\text{ nH}$, $V_{GS} = -3/18\text{ V}$, $R_{Gon} = 6.8\ \Omega$, $di/dt = 3.6\text{ kA}/\mu\text{s}$ ($T_{vj} = 175\text{ }^\circ\text{C}$)	$T_{vj} = 25\text{ }^\circ\text{C}$	0.79		mJ
			$T_{vj} = 125\text{ }^\circ\text{C}$	0.91		
			$T_{vj} = 175\text{ }^\circ\text{C}$	1.02		
Turn-off energy loss per pulse	E_{off}	$I_D = 50\text{ A}$, $V_{DD} = 600\text{ V}$, $L_\sigma = 35\text{ nH}$, $V_{GS} = -3/18\text{ V}$, $R_{Goff} = 1\ \Omega$, $dv/dt = 34.3\text{ kV}/\mu\text{s}$ ($T_{vj} = 175\text{ }^\circ\text{C}$)	$T_{vj} = 25\text{ }^\circ\text{C}$	0.14		mJ
			$T_{vj} = 125\text{ }^\circ\text{C}$	0.148		
			$T_{vj} = 175\text{ }^\circ\text{C}$	0.157		
SC data	I_{SC}	$V_{GS} = -5/15\text{ V}$, $V_{DD} = 800\text{ V}$, $V_{DSmax} = V_{DSS} - L_{SDS} \cdot di/dt$, $R_G = 10\ \Omega$	$t_P = 2\ \mu\text{s}$, $T_{vj} = 25\text{ }^\circ\text{C}$	420		A
			$t_P = 2\ \mu\text{s}$, $T_{vj} = 150\text{ }^\circ\text{C}$	410		
Thermal resistance, junction to heat sink	R_{thJH}	per MOSFET, $\lambda_{grease} = 1\text{ W}/(\text{m}\cdot\text{K})$		0.8		K/W
Temperature under switching conditions	$T_{vj\text{ op}}$		-40		175	$^\circ\text{C}$

Note: The selection of positive and negative gate-source voltages impacts losses and the long-term behavior of the MOSFET and body diode. The design guidelines described in Application Note AN 2018-09 and AN 2021-13 must be considered to ensure sound operation of the device over the planned lifetime.

$T_{vj,op} > 150\text{ }^\circ\text{C}$ is allowed for operation at overload conditions for MOSFET and body diode. For detailed specifications, please refer to AN 2021-13

3 Body diode (MOSFET)

Table 6 **Maximum rated values**

Parameter	Symbol	Note or test condition	Values	Unit
DC body diode forward current	I_{SD}	$T_{vj} = 175\text{ }^\circ\text{C}$, $V_{GS} = -3\text{ V}$ $T_H = 80\text{ }^\circ\text{C}$	25	A

Table 7 **Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_{SD}	$I_{SD} = 50\text{ A}$, $V_{GS} = -3\text{ V}$	$T_{vj} = 25\text{ }^\circ\text{C}$	4.2	5.35	V
			$T_{vj} = 125\text{ }^\circ\text{C}$	3.9		
			$T_{vj} = 175\text{ }^\circ\text{C}$	3.8		

4 NTC-Thermistor

Table 8 Characteristic values

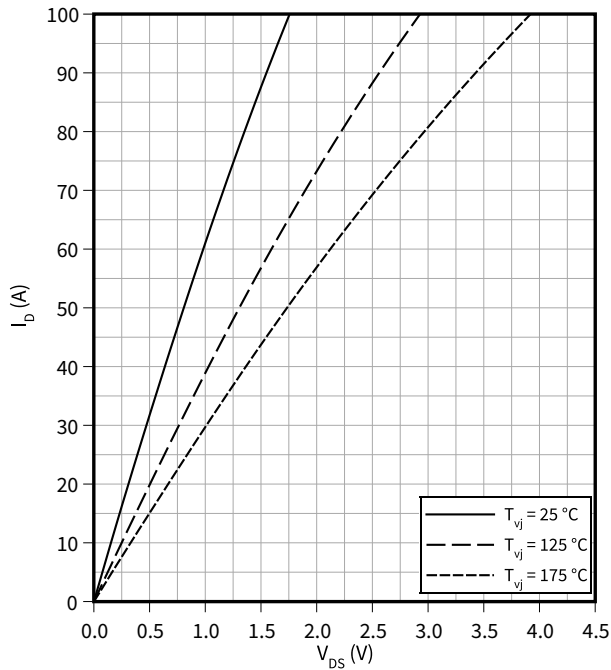
Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	R_{25}	$T_{NTC} = 25\text{ °C}$		5		kΩ
Deviation of R_{100}	$\Delta R/R$	$T_{NTC} = 100\text{ °C}, R_{100} = 493\text{ Ω}$	-5		5	%
Power dissipation	P_{25}	$T_{NTC} = 25\text{ °C}$			20	mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15\text{ K}))]$		3375		K
B-value	$B_{25/80}$	$R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15\text{ K}))]$		3411		K
B-value	$B_{25/100}$	$R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15\text{ K}))]$		3433		K

Note: Specification according to the valid application note.

5 Characteristics diagrams

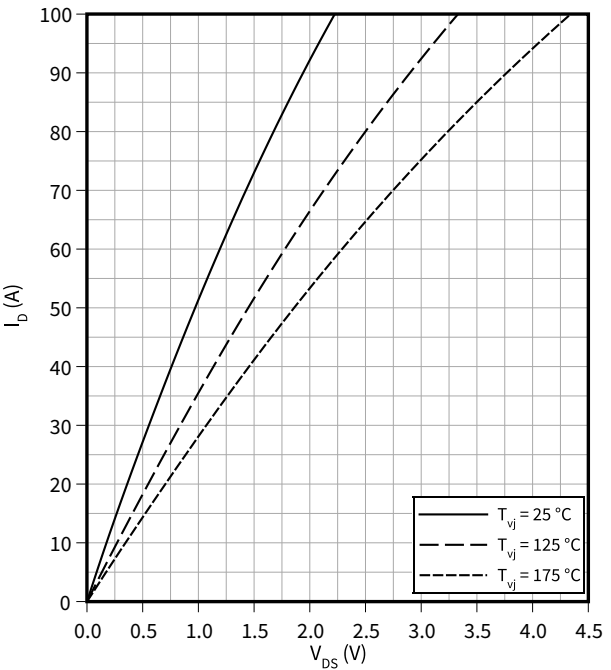
Output characteristic (typical), MOSFET

$I_D = f(V_{DS})$
 $V_{GS} = 18\text{ V}$



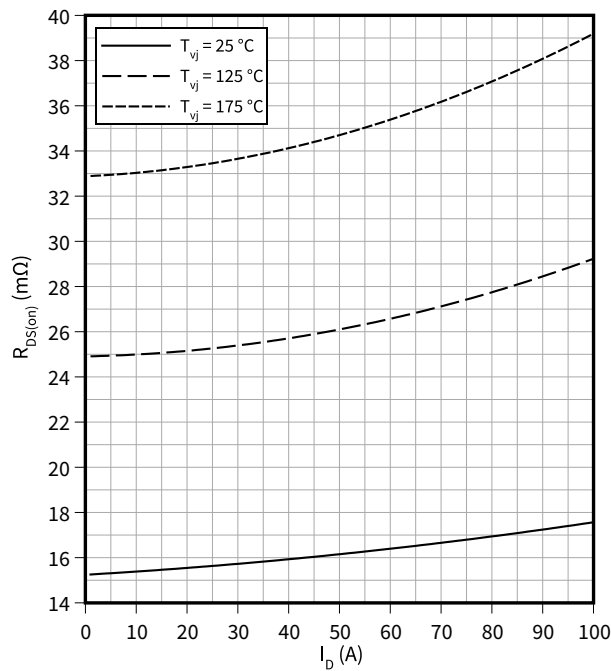
Output characteristic (typical), MOSFET

$I_D = f(V_{DS})$
 $V_{GS} = 15\text{ V}$



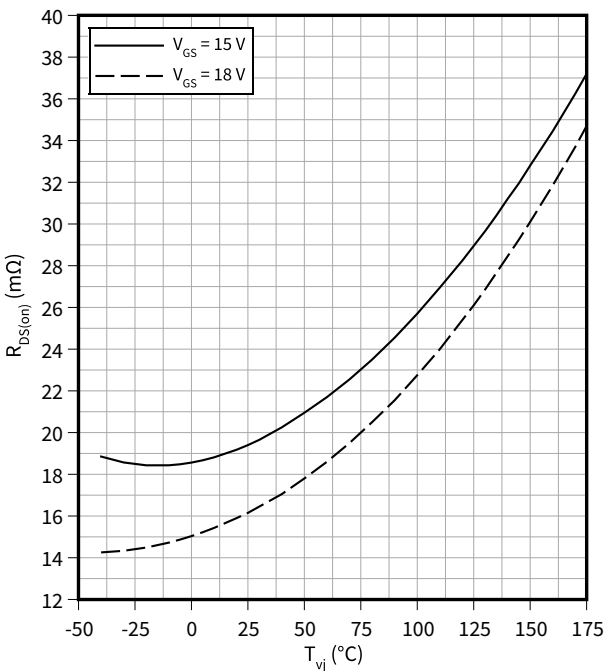
Drain source on-resistance (typical), MOSFET

$R_{DS(on)} = f(I_D)$
 $V_{GS} = 18\text{ V}$



Drain source on-resistance (typical), MOSFET

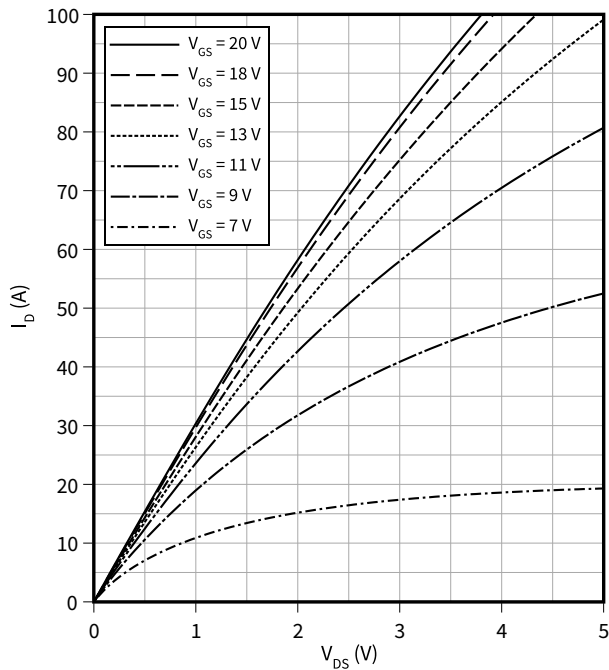
$R_{DS(on)} = f(T_{vj})$
 $I_D = 50\text{ A}$



5 Characteristics diagrams

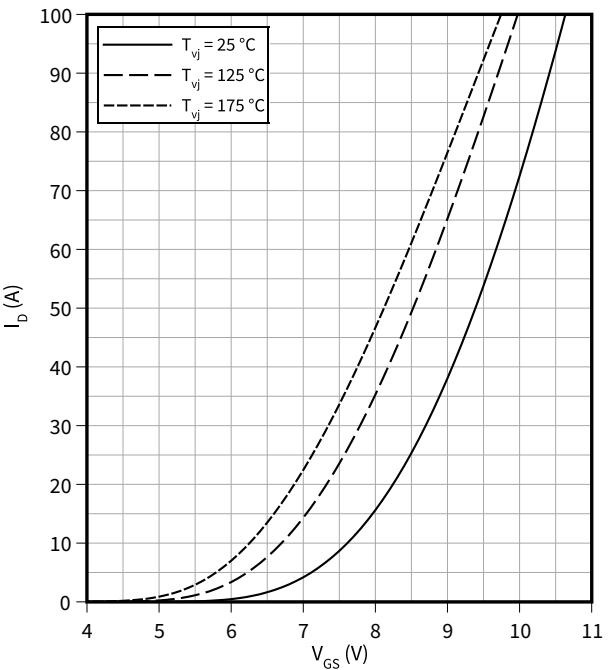
Output characteristic field (typical), MOSFET

$I_D = f(V_{DS})$
 $T_{vj} = 175\text{ °C}$



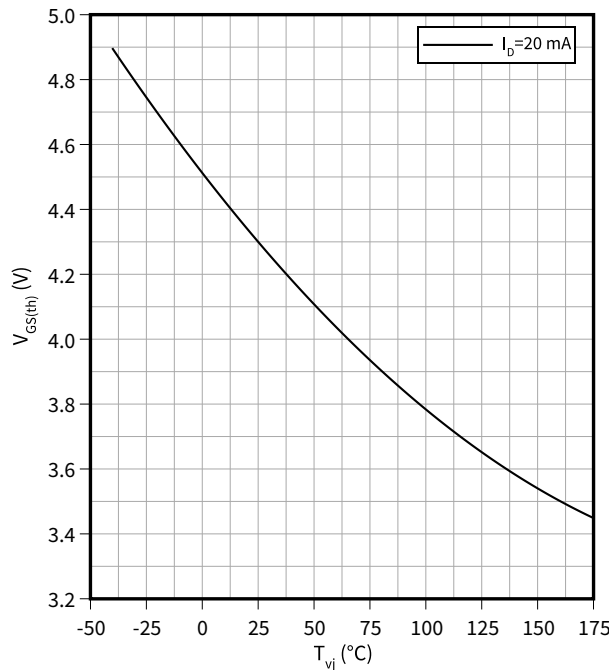
Transfer characteristic (typical), MOSFET

$I_D = f(V_{GS})$
 $V_{DS} = 20\text{ V}$



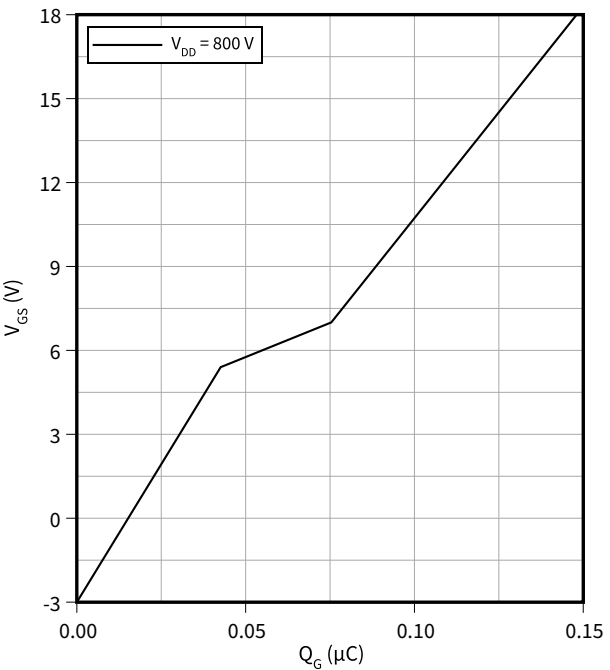
Gate-source threshold voltage (typical), MOSFET

$V_{GS(th)} = f(T_{vj})$
 $V_{GS} = V_{DS}$



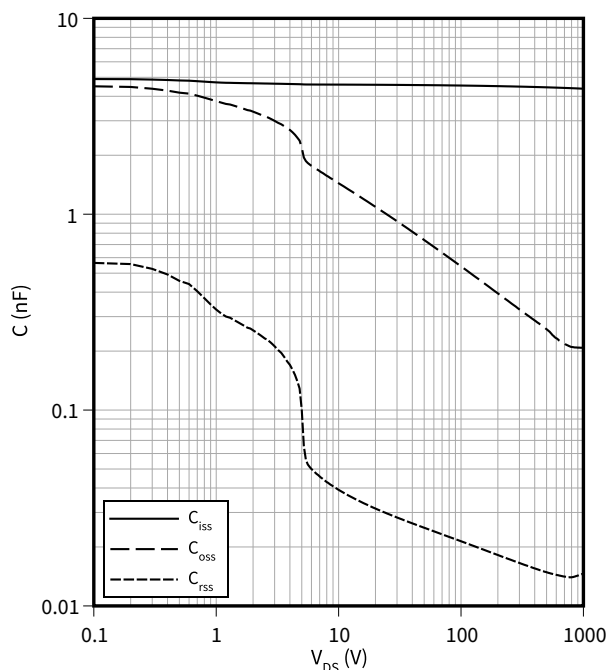
Gate charge characteristic (typical), MOSFET

$V_{GS} = f(Q_G)$
 $I_D = 50\text{ A}, T_{vj} = 25\text{ °C}$

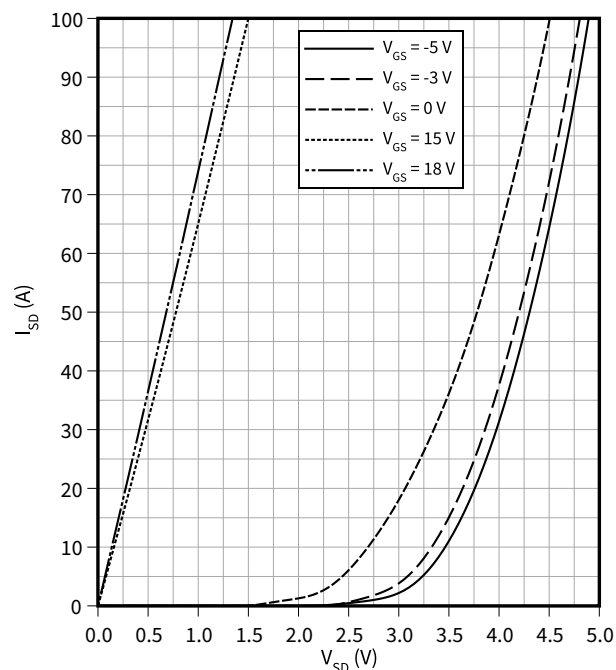


Capacity characteristic (typical), MOSFET

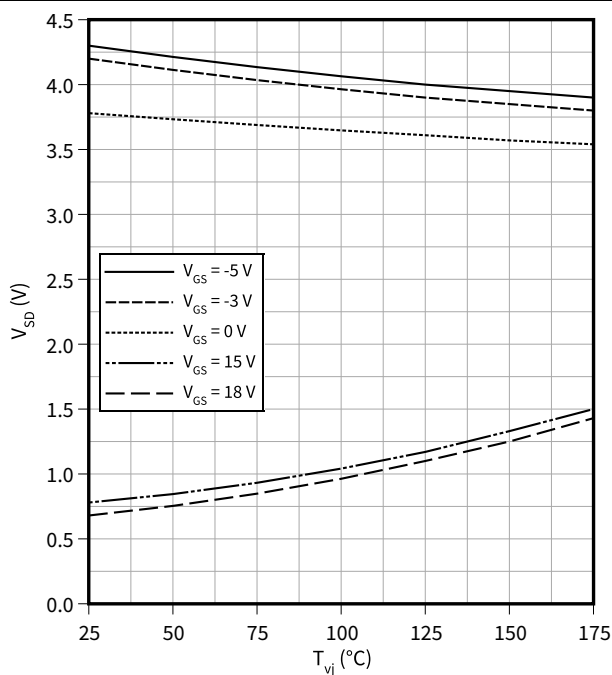
$$C = f(V_{DS})$$

 $f = 100 \text{ kHz}, T_{vj} = 25^\circ\text{C}, V_{GS} = 0 \text{ V}$
**Forward characteristic body diode (typical), MOSFET**

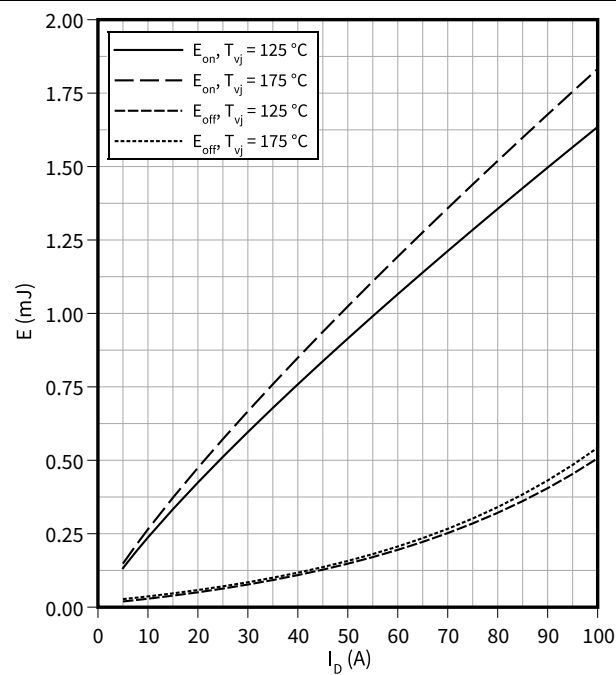
$$I_{SD} = f(V_{SD})$$

 $T_{vj} = 25^\circ\text{C}$
**Forward voltage of body diode (typical), MOSFET**

$$V_{SD} = f(T_{vj})$$

 $I_{SD} = 50 \text{ A}$
**Switching losses (typical), MOSFET**

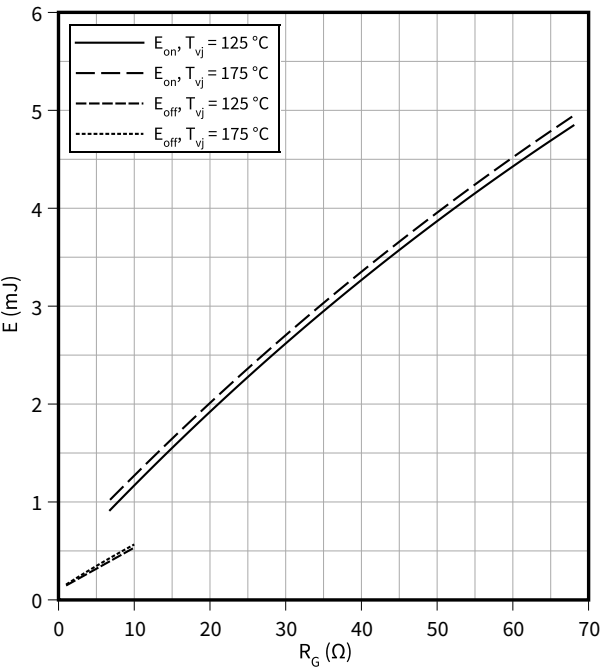
$$E = f(I_D)$$

 $R_{Goff} = 1 \Omega, R_{Gon} = 6.8 \Omega, V_{DD} = 600 \text{ V}, V_{GS} = -3/18 \text{ V}$


5 Characteristics diagrams

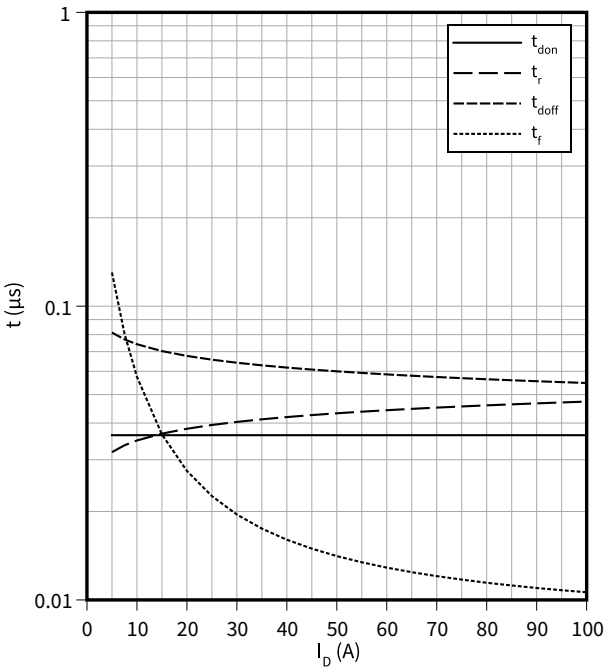
Switching losses (typical), MOSFET

$E = f(R_G)$
 $V_{DD} = 600\text{ V}$, $I_D = 50\text{ A}$, $V_{GS} = -3/18\text{ V}$



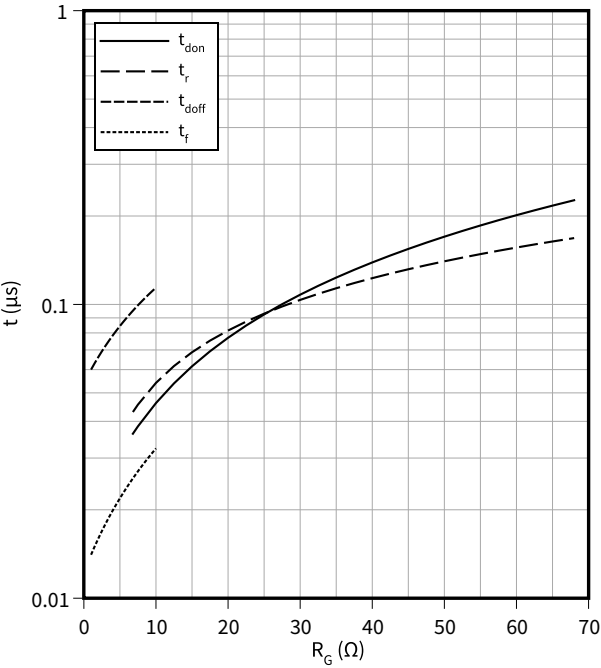
Switching times (typical), MOSFET

$t = f(I_D)$
 $R_{Goff} = 1\text{ }\Omega$, $R_{Gon} = 6.8\text{ }\Omega$, $V_{DD} = 600\text{ V}$, $T_{vj} = 175\text{ }^\circ\text{C}$, $V_{GS} = -3/18\text{ V}$



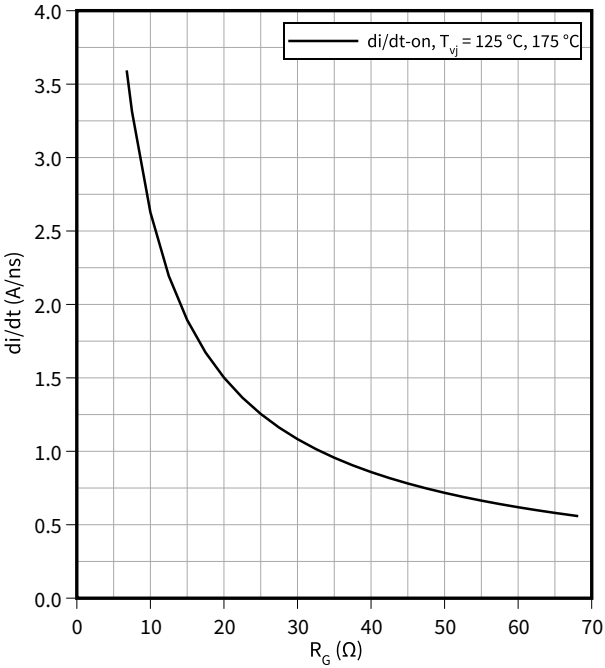
Switching times (typical), MOSFET

$t = f(R_G)$
 $V_{DD} = 600\text{ V}$, $I_D = 50\text{ A}$, $T_{vj} = 175\text{ }^\circ\text{C}$, $V_{GS} = -3/18\text{ V}$



Current slope (typical), MOSFET

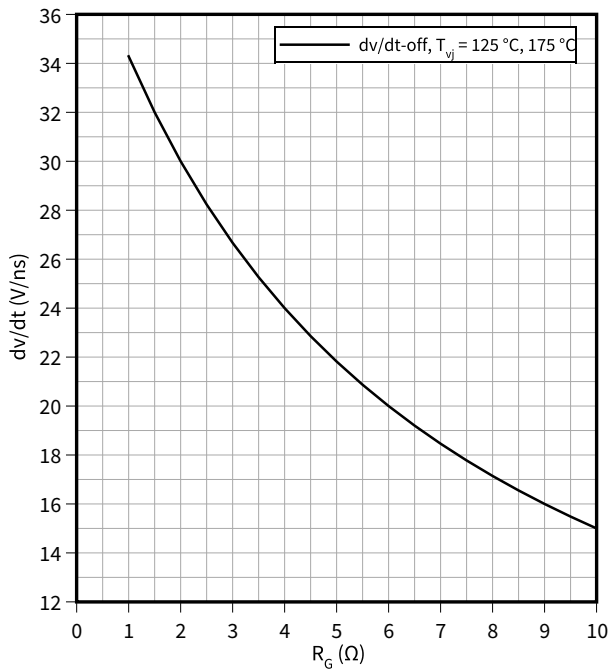
$di/dt = f(R_G)$
 $V_{DD} = 600\text{ V}$, $I_D = 50\text{ A}$, $V_{GS} = -3/18\text{ V}$



5 Characteristics diagrams

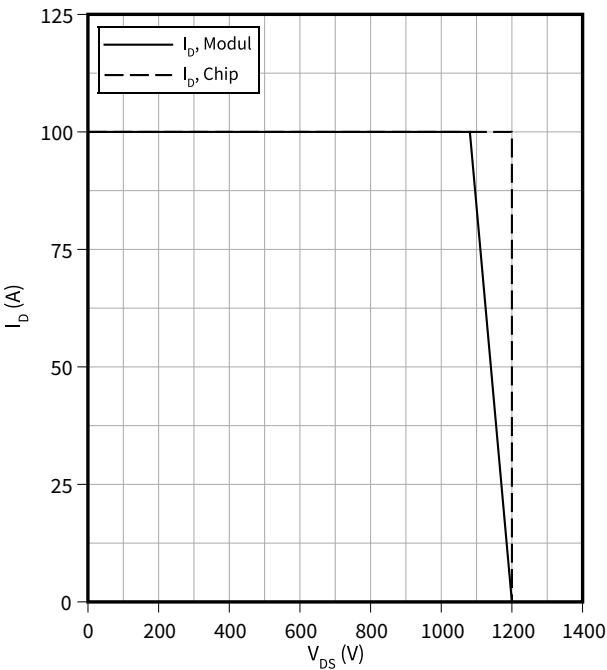
Voltage slope (typical), MOSFET

$dv/dt = f(R_G)$
 $V_{DD} = 600\text{ V}$, $I_D = 50\text{ A}$, $V_{GS} = -3/18\text{ V}$



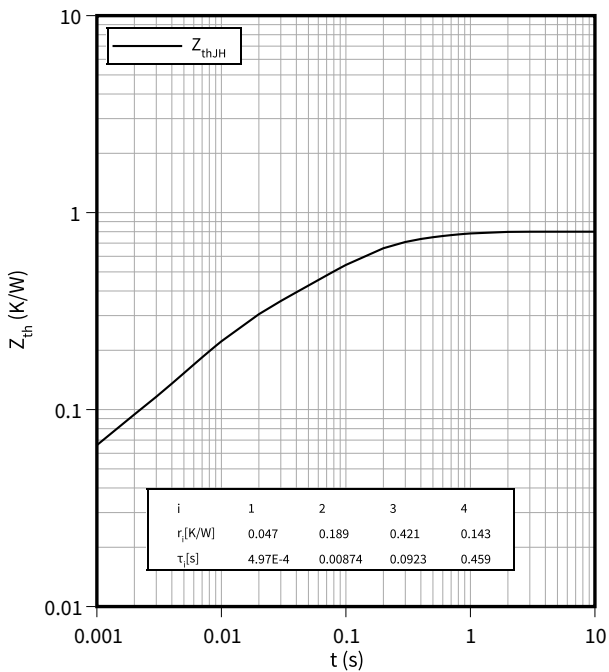
Reverse bias safe operating area (RBSOA), MOSFET

$I_D = f(V_{DS})$
 $R_{Goff} = 1\text{ }\Omega$, $T_{vj} = 175\text{ }^\circ\text{C}$, $V_{GS} = -3/18\text{ V}$



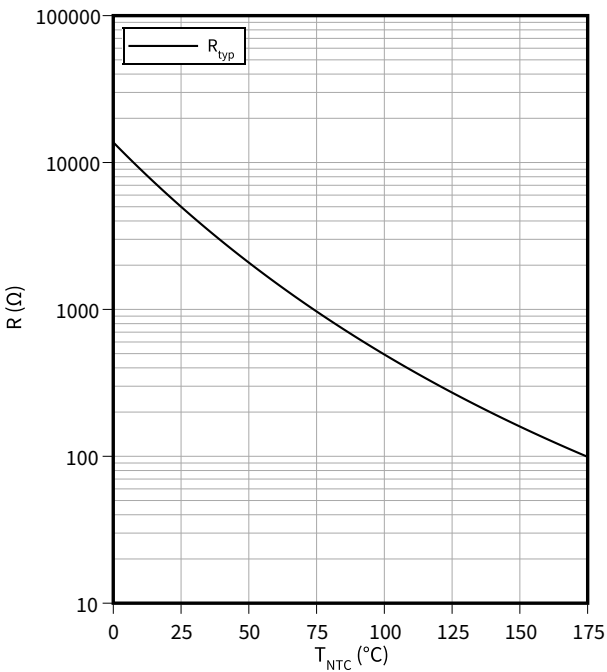
Transient thermal impedance , MOSFET

$Z_{th} = f(t)$



Temperature characteristic (typical), NTC-Thermistor

$R = f(T_{NTC})$



6 Circuit diagram

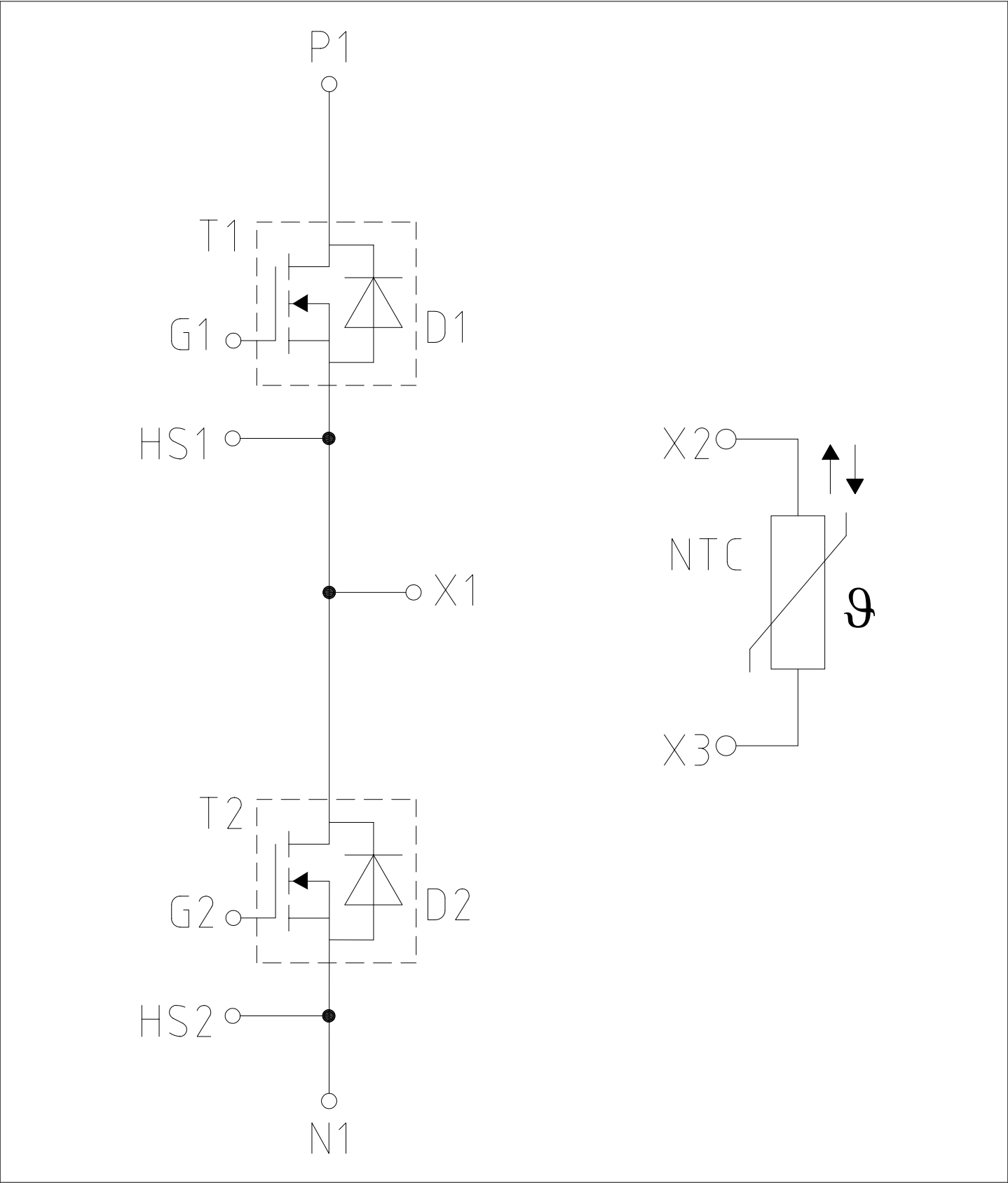


Figure 1

7 Package outlines

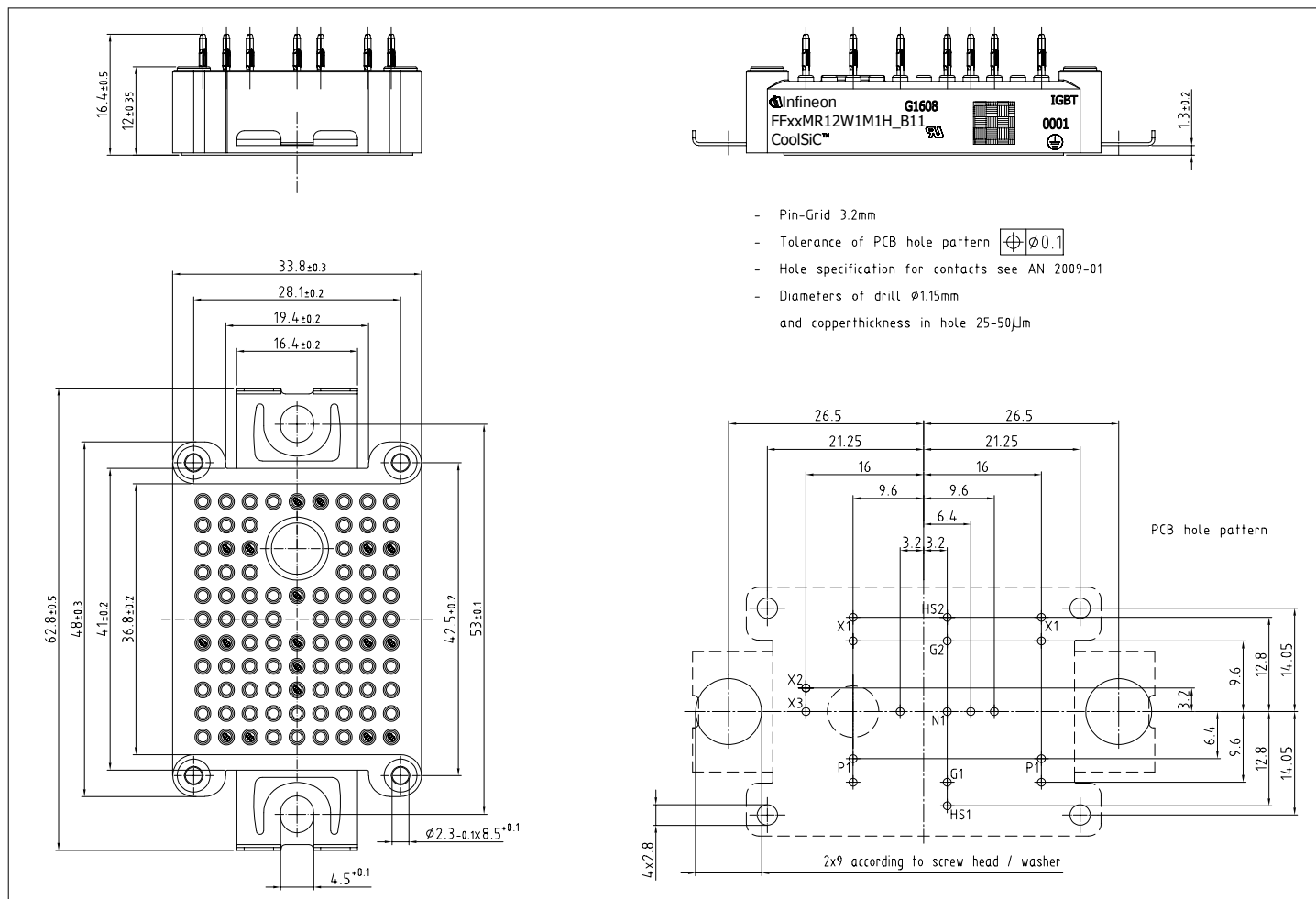


Figure 2

8 Module label code

Module label code			
Code format	Data Matrix		Barcode Code128
Encoding	ASCII text		Code Set A
Symbol size	16x16		23 digits
Standard	IEC24720 and IEC16022		IEC8859-1
Code content	<i>Content</i>	<i>Digit</i>	<i>Example</i>
	Module serial number	1 – 5	71549
	Module material number	6 - 11	142846
	Production order number	12 - 19	55054991
	Date code (production year)	20 – 21	15
	Date code (production week)	22 – 23	30
Example			
			
71549142846550549911530		71549142846550549911530	

Figure 3

Revision history

Document revision	Date of release	Description of changes
0.10	2022-08-04	Initial version
0.20	2023-01-24	Preliminary datasheet
0.30	2023-02-07	Preliminary datasheet

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